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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP: RX230

DEVICE: R5F5230XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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## Table. Reliability test results (QFP)

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Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $^{\circ}$ to 150 $^{\circ}$ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)		245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat JESD22-A113, (PC) J-STD-020		MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



## Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $^{\circ}$ C to 150 $^{\circ}$ C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM) JS-001		1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	0/3	Class: Equivalent to C2b
Solderability (SD)	J-STD-002 245 ℃, 5 s, Solder coverage ≥95 %		0/5	
Resistance to Soldering Heat JESD22-A113, (PC) J-STD-020		MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



## Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)		Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)		Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ C to 125 $^{\circ}$ C , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	I + I = I + I = I + I = I + I = I = I =		0/3	Class: Equivalent to C2b
Resistance to Soldering Heat JESD22-A113, (PC) J-STD-020		MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

#### •Equation for the failure rate estimation ( $\lambda$ )

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 3.8 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV)
Ta: Ambient temperature (℃)

$\pi$ T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

## ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



#### Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

#### Table. Product list

Table	e. Product lis	ST .					
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RX230	R5F52305ADFL	PLQP0048K*	51			
2	RX230	R5F52305AGFL	PLQP0048K*	52			
3	RX230	R5F52306ADFL	PLQP0048K*	53			
4	RX230	R5F52306AGFL	PLQP0048K*	54			
5	RX230	R5F52305ADFM	PLQP0064K*	55			
6	RX230	R5F52305AGFM	PLQP0064K*	56			
7	RX230	R5F52306ADFM	PLQP0064K*	57			
8	RX230	R5F52306AGFM	PLQP0064K*	58			
9	RX230	R5F52305ADFP	PLQP0100K*	59			
10	RX230	R5F52305AGFP	PLQP0100K*	60			
11	RX230	R5F52306ADFP	PLQP0100K*	61			
12	RX230	R5F52306AGFP	PLQP0100K*	62			
13	RX230	R5F52305ADLA	PTLG0100K*	63			
14	RX230	R5F52306ADLA	PTLG0100K*	64			
15	RX230	R5F52305ADLF	PWLG0064K*	65			
16	RX230	R5F52306ADLF	PWLG0064K*	66			
17	RX230	R5F52305ADND	PWQN0064K*	67			
18	RX230	R5F52305AGND	PWQN0064K*	68			
19	RX230	R5F52306ADND	PWQN0064K*	69			
20	RX230	R5F52306AGND	PWQN0064K*	70			
21	RX230	R5F52305ADNE	PWQN0048K*	71			
22	RX230	R5F52305AGNE	PWQN0048K*	72			
23	RX230	R5F52306ADNE	PWQN0048K*	73			
24	RX230	R5F52306AGNE	PWQN0048K*	74			
25				75			
26				76			
27				77			
28				78			
29				79			
30				80			
31				81			
32				82			
33				83			
34				84			
35				85			
36				86			
37				87			
38				88			
39				89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98			
49				99			
50				100			